

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	357	381/91.ccls.	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2009/06/22 15:02
L3	10186	(microphone) and (condenser capacitive electret capacitive)	US-PGPUB; USPAT	OR	ON	2009/06/22 15:03
L4	68	L2 and L3	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2009/06/22 15:03
S1	3	((KATSUHIRO) near2 (MAKI HATA)).INV.	US-PGPUB; USPAT	OR	ON	2008/08/04 10:23
S2	53	((HIROSHI) near2 (OGURA)).INV.	US-PGPUB; USPAT	OR	ON	2008/08/04 10:23
S3	7	((YOSHINOBU) near2 (YASUNO)).INV.	USPAT	OR	ON	2008/08/04 10:23
S4	22	S2 not (S1 S3)	USPAT	OR	ON	2008/08/04 10:35
S6	1	"6818092".pn.	USPAT	OR	ON	2008/08/04 10:40
S8	1	"20030113546"	US-PGPUB; USPAT	OR	ON	2008/08/04 10:42
S9	12	("2787671" "2852620" "20020009202" "20020110254" "20030026443" "20030133588" "20050025328" "3031538" "4281222" "4817168" "6130952" "7003127").PN.	US-PGPUB; USPAT	OR	ON	2008/08/04 10:42
S10	12	((YOSHINOBU) near2 (YASUNO)).INV.	US-PGPUB; USPAT	OR	ON	2008/08/04 10:43
S11	5	S10 not S3	US-PGPUB; USPAT	OR	ON	2008/08/04 10:43
S12	196	381/369.ccls.	US-PGPUB; USPAT	OR	ON	2008/08/04 11:03
S13	419	381/174.ccls.	US-PGPUB; USPAT	OR	ON	2008/08/04 11:03
S14	240	381/178.ccls.	US-PGPUB; USPAT	OR	ON	2008/08/04 11:03
S15	157	181/158.ccls.	US-PGPUB; USPAT	OR	ON	2008/08/04 11:03

S16	8858	(microphone) and (condenser capacitive electret capacative)	US-PGPUB; USPAT	OR	ON	2008/08/04 11:07
S18	1	S16 and (((deform deforming) and (dissipating)) near (temperature temperture))	US-PGPUB; USPAT	OR	ON	2008/08/04 11:09
S21	13808	(microphone) and (condenser capacitive electret capacative)	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2008/08/04 12:47
S23	8858	(microphone) and (condenser capacitive electret capacative)	US-PGPUB; USPAT	OR	ON	2008/08/04 14:39
S24	461	S23 and (PTFE teflon)	US-PGPUB; USPAT	OR	ON	2008/08/04 14:39
S25	86	S24 and (reflow solder)	US-PGPUB; USPAT	OR	ON	2008/08/04 14:40
S26	4950	(microphone) and (condenser capacitive electret capacative)	USOCR; DERWENT; IBM_TDB	OR	ON	2008/08/04 15:05
S27	46	S26 and (PTFE teflon)	USOCR; DERWENT; IBM_TDB	OR	ON	2008/08/04 15:05
S28	0	S24 and (reflow solder)	USOCR; DERWENT; IBM_TDB	OR	ON	2008/08/04 15:05
S29	594	29/594.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2008/08/04 15:30
S30	13819	(microphone) and (condenser capacitive electret capacative)	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2008/08/05 10:09
S31	906	S30 and ((silicon adj (oxide dioxide di\$1oxide)) ("SiO. sub.2") nitride)	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2008/08/05 10:09
S32	172	S31 and (reflow solder)	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2008/08/05 10:10
S33	19	S32 and (discharge discharging)	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2008/08/05 12:30
S34	3	"3946422".pn.	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2008/08/05 12:39

S35	0	(10/576518).APP.	USPAT; USOCR	OR	ON	2008/08/05 13:26
S36	217	381/369.ccls.	US-PGPUB; USPAT	OR	ON	2009/06/22 11:50
S37	452	381/174.ccls.	US-PGPUB; USPAT	OR	ON	2009/06/22 11:50
S38	240	381/178.ccls.	US-PGPUB; USPAT	OR	ON	2009/06/22 11:50
S39	157	181/158.ccls.	US-PGPUB; USPAT	OR	ON	2009/06/22 11:50
S40	675	29/594.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2009/06/22 11:50
S41	15278	(microphone) and (condenser capacitive electret capacative)	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2009/06/22 11:50
S42	1058	S41 and ((silicon adj (oxide dioxide di\$1oxide)) ("SiO. sub.2") nitride)	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2009/06/22 11:50
S43	198	S42 and (reflow solder)	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2009/06/22 11:50
S44	54	(S36 S37 S38 S39 S40 S43) &@pd>="20090309"	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2009/06/22 11:50

6/ 22/ 2009 3:08:18 PM

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